

Description

The 74LVC07A provides six independent open-drain buffers. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed-voltage environment. The device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down. The outputs can be connected to implement active-low wired-OR or active-high wired-AND functions.

The gates perform the positive Boolean function:

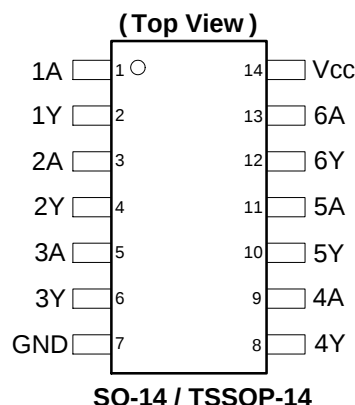
$$Y = A$$

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- Sinks 24mA at $V_{CC} = 3.3V$
- CMOS low power consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs or outputs accept up to 5.5V
- Inputs can be driven by 3.3V or 5.5V allowing for voltage translation applications.
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 250 mA per JESD 78, Class II
- Range of Package Options SO-14 and TSSOP-14
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.**
<https://www.diodes.com/quality/product-definitions/>

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



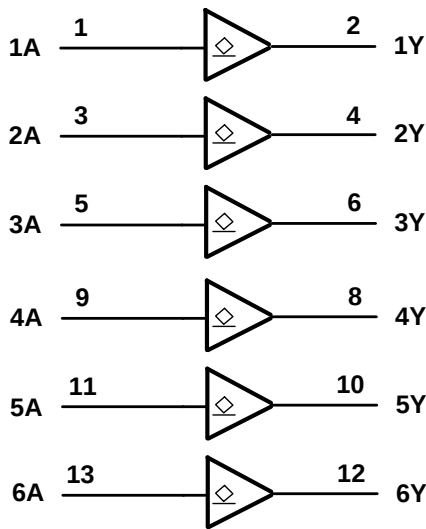
Applications

- Voltage level shifting
- General-purpose logic
- Power down signal isolation
- Wide array of products such as:
 - PCs, networking, notebooks, ultrabooks, netbooks
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top boxes

Pin Descriptions

Pin Number	Pin Name	Description
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Inputs	Outputs
A	Y
L	L
H	Z

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to +6.5	V
V _I	Input Voltage Range	-0.5 to +6.5	V
V _O	Voltage applied to output in high impedance or I _{OFF} State	-0.5 to +6.5	V
V _O	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I < 0	-50	mA
I _{OK}	Output Clamp Current V _O < 0	-50	mA
I _O	Continuous output current	50	mA
—	Continuous current through V _{DD} or GND	±100	mA
T _J	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage	—	1.65	5.5	V
V _I	Input Voltage	—	0	5.5	V
V _O	Output Voltage	Active Mode	0	V _{CC}	V
		V _{CC} = 0V; Power Down Mode	0	5.5	V
Δt/ΔV	Input transition rise or fall rate	V _{CC} = 1.65V to 2.7V	—	20	ns/V
		V _{CC} = 2.7V to 5.5V	—	10	
T _A	Operating free-air temperature	—	-40	+125	°C

Note: 5. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	V _{CC}	T _A = -40°C to +85°C		T _A = -40°C to +125°C		Unit
				Min	Max	Min	Max	
V _{IH}	High-level Input Voltage	—	1.65V to 1.95V	0.65 X V _{CC}	—	0.65 X V _{CC}	—	V
		—	2.3V to 2.7V	1.7	—	1.6	—	
		—	2.7V to 3.6V	2.0	—	2.0	—	
		—	4.5V to 5.5V	0.7 X V _{CC}	—	2.0	—	
V _{IL}	Low-level input voltage	—	1.65V to 1.95V	—	0.35 X V _{CC}	—	0.35 X V _{CC}	V
		—	2.3V to 2.7V	—	0.7	—	0.7	
		—	2.7V to 3.6V	—	0.8	—	0.8	
		—	4.5V to 5.5V	—	0.3 X V _{CC}	—	0.3 X V _{CC}	
V _{OL}	Low-level Output Voltage	I _{OL} = 100μA	1.65V to 5.5V	—	0.2	—	0.3	V
		I _{OL} = 4mA	1.65V	—	0.45	—	0.6	
		I _{OL} = 8mA	2.3V	—	0.70	—	0.85	
		I _{OL} = 12mA	2.7V	—	0.40	—	0.6	
			3.0V	—	0.55	—	0.6	
		I _{OL} = 24mA	3.0V	—	0.55	—	0.6	
		I _{OL} = 32mA	4.5V	—	0.55	—	0.6	
I _I	Input Current	V _I = GND to 5.5V	3.6V	—	± 5	—	± 20	μA
I _{OZ}	Z State Leakage Current	V _O = GND or 5.5V	3.6V	—	±10	—	±20	μA
I _{OFF}	Power Down Leakage Current	V _I or V _O = 0V to 3.6V	0	—	10	—	20	μA
I _{CC}	Supply Current	V _I = GND or V _{CC} I _O = 0	3.6V	—	10	—	40	μA

Switching Characteristics

Symbol	Parameter	Test Conditions	V _{CC}	T _A = +25°C			-40°C to +85°C		-40°C to +125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t _{PLZ} / t _{PZL}	Propagation Delay A _N to Y _N	Figure 1	1.65V to 1.95V	0.3	2.9	5.7	0.3	5.8	0.3	7.6	ns
			2.3V to 2.7V	0.3	2.6	4.1	0.3	4.7	0.3	5.5	
			2.7V	0.3	2.5	4.0	0.3	4.5	0.3	5.0	
			3V to 3.6V	0.3	2.3	3.5	0.3	3.7	0.3	5.0	
			4.5V to 5.5V	0.3	1.7	3.2	0.3	3.4	0.3	4.5	

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

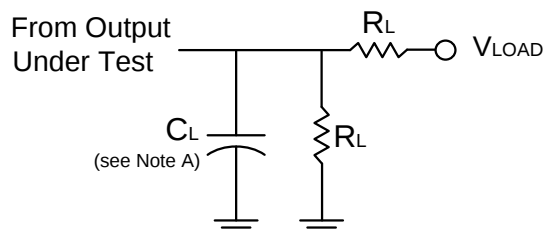
Parameter		Test Conditions	V _{CC} = 1.8V	V _{CC} = 2.5V	V _{CC} = 3.3V	V _{CC} = 5V	Unit
			Typ	Typ	Typ	Typ	
C _{pd}	Power dissipation capacitance per gate	f = 10 MHz	7.0	7.5	8.0	8.6	pF
C _I	Input Capacitance	V _I = V _{CC} – or GND	4	4	4	4	pF

Package Characteristics

Symbol	Parameter	Test Conditions	V _{CC}	Min	Typ	Max	Unit
θ _{JA}	Thermal Resistance Junction-to-Ambient	SO-14	(Note 6)		TBD		°C/W
		TSSOP-14			159		
θ _{JC}	Thermal Resistance Junction-to-Case	SO-14	(Note 6)		TBD		°C/W
		TSSOP-14			25		

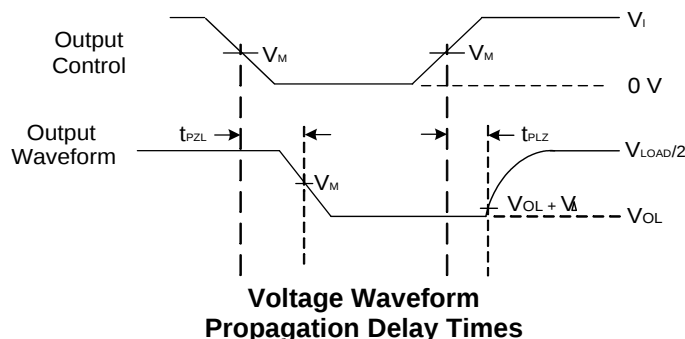
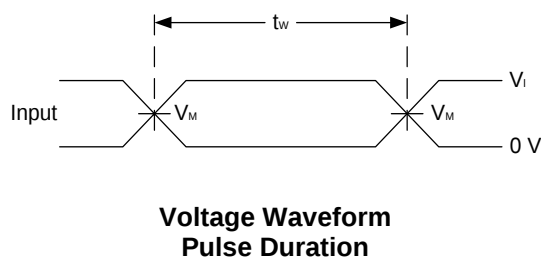
Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Parameter Measurement Information



TEST	Condition
t_{PLZ} (see Note E)	V_{LOAD}
t_{PZL} (see Note D)	V_{LOAD}

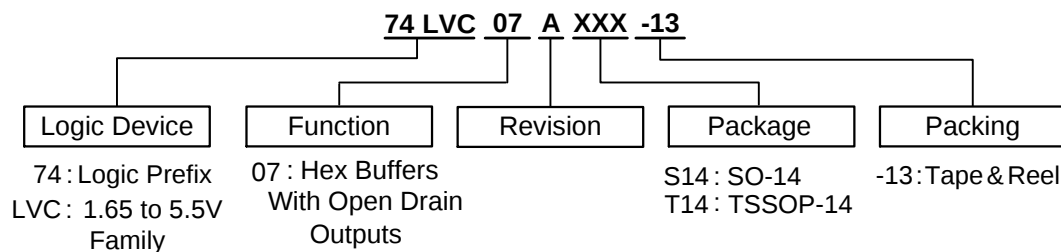
V_{CC}	Inputs		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
$1.8V \pm 0.15V$	V_{CC}	$\leq 2ns$	$V_{CC}/2$	$2 \times V_{CC}$	30pF	1K Ω	0.15V
$2.5V \pm 0.2V$	V_{CC}	$\leq 2ns$	$V_{CC}/2$	$2 \times V_{CC}$	30pF	500 Ω	0.15V
2.7V	2.7V	$\leq 2ns$	1.5V	6V	50pF	500 Ω	0.3V
$3.3V \pm 0.3V$	3V	$\leq 2.5ns$	1.5V	6V	50pF	500 Ω	0.3V
$5V \pm 0.5V$	V_{CC}	$\leq 2.5ns$	$V_{CC}/2$	$2 \times V_{CC}$	50pF	500 Ω	0.3V



- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
 - C. The inputs are measured one at a time with one transition per measurement.
 - D. t_{PZL} is measured at V_M .
 - E. t_{PLZ} is measured at $V_{OL} + V_{\Delta}$

Figure 1. Load Circuit and Voltage Waveforms

Ordering Information

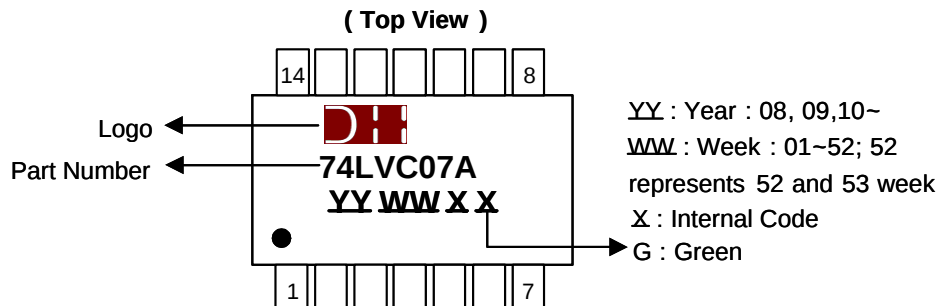


Orderable Part Number	Package Code	Package (Note 7)	Packing		
			Quantity	Carrier	Part Number Suffix
74LVC07AS14-13	S14	SO-14	2,500	13" Tape & Reel	-13
74LVC07AT14-13	T14	TSSOP-14	2,500	13" Tape & Reel	-13

Note: 7. The taping orientation and tape details can be found at <http://www.diodes.com/datasheets/ap02007.pdf>

Marking Information

(1) SO-14, TSSOP-14

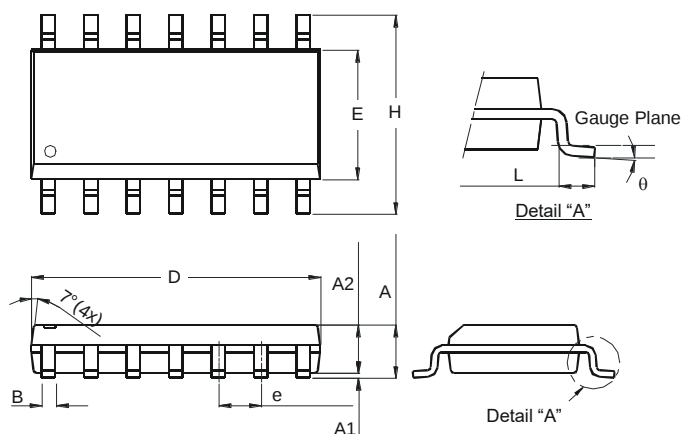


Part Number	Package
74LVC07AS14	SO-14
74LVC07AT14	TSSOP-14

Package Outline Dimensions (All dimensions in mm.)

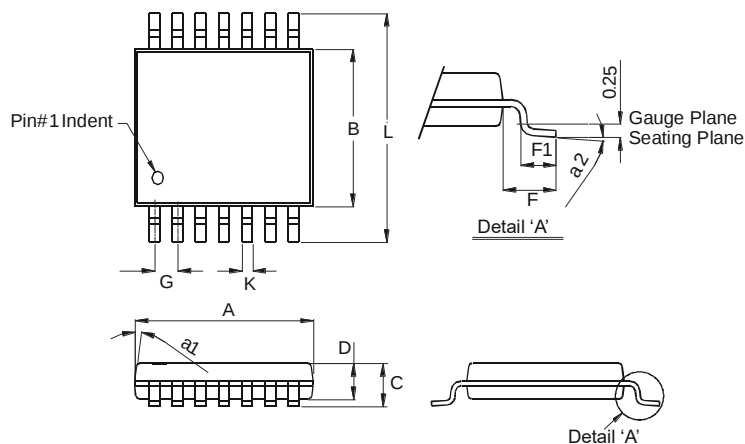
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-14



SO-14		
Dim	Min	Max
A	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
B	0.33	0.51
D	8.53	8.74
E	3.80	3.99
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Dimensions in mm		

TSSOP-14

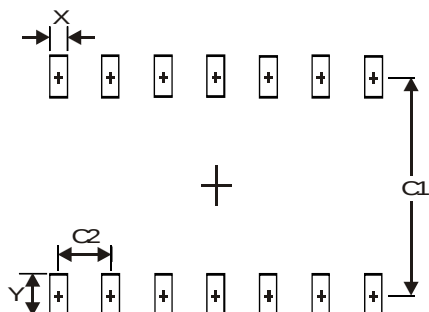


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
A	4.9	5.10
B	4.30	4.50
C	-	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		

Suggested Pad Layout

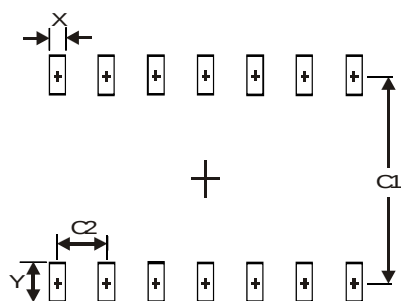
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-14



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

TSSOP-14



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65

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